I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. :



I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C Eisenhart, Registration No. 38,128, and Carol L.Druzbick, Registration No. 40,287; and Anthony H. Nourse, Registration No. 46,121, all of the control of the

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with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Tradémark Office connected therewith, and all further correspondence should be addressed to them

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